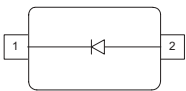


Silicon Schottky Diode

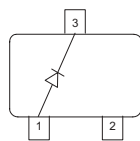
- General-purpose diode for high-speed switching
- Circuit protection
- Voltage clamping
- High-level detecting and mixing
- BAS70-04S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101



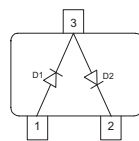
BAS170W
BAS70-02L
BAS70-02W



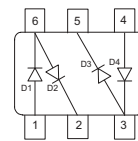
BAS70



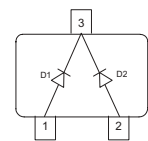
BAS70-04
BAS70-04W



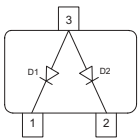
BAS70-04S



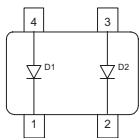
BAS70-05
BAS70-05W



BAS70-06
BAS70-06W



BAS70-07
BAS70-07W



¹Pb-containing package may be available upon special request

| Type | Package | Configuration | L_S (nH) | Marking |
|-----------|----------|------------------|------------|---------|
| BAS170W | SOD323 | single | 1.8 | white 7 |
| BAS70 | SOT23 | single | 1.8 | 73s |
| BAS70-02L | TSLP-2-1 | single, leadless | 0.4 | F |
| BAS70-02W | SCD80 | single | 0.6 | 73 |
| BAS70-04 | SOT23 | series | 1.8 | 74s |
| BAS70-04S | SOT363 | dual series | 1.6 | 74s |
| BAS70-04W | SOT323 | series | 1.4 | 74s |
| BAS70-05 | SOT23 | common cathode | 1.8 | 75s |
| BAS70-05W | SOT323 | common cathode | 1.4 | 75s |
| BAS70-06 | SOT23 | common anode | 1.8 | 76s |
| BAS70-06W | SOT323 | common anode | 1.4 | 76s |
| BAS70-07 | SOT143 | parallel pair | 2 | 77s |
| BAS70-07W | SOT343 | parallel pair | 1.8 | 77s |

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|---|-----------|-------------|------------------|
| Diode reverse voltage | V_R | 70 | V |
| Forward current | I_F | 70 | mA |
| Non-repetitive peak surge forward current $t \leq 10\text{ms}$ | I_{FSM} | 100 | |
| Total power dissipation | P_{tot} | | mW |
| BAS70, BAS70-07, $T_S \leq 72^\circ\text{C}$ | | 250 | |
| BAS70-02L, $T_S \leq 117^\circ\text{C}$ | | 250 | |
| BAS70-02W, $T_S \leq 107^\circ\text{C}$ | | 250 | |
| BAS70-04, BAS70-06, $T_S \leq 48^\circ\text{C}$ | | 250 | |
| BAS70-04S/W/-06W, BAS170W, $T_S \leq 97^\circ\text{C}$ | | 250 | |
| BAS70-05, $T_S \leq 22^\circ\text{C}$ | | 250 | |
| BAS70-05W, $T_S \leq 90^\circ\text{C}$ | | 250 | |
| BAS70-07W, $T_S \leq 114^\circ\text{C}$ | | 250 | |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Operating temperature range | T_{op} | -55 ... 125 | |
| Storage temperature | T_{stg} | -55 ... 150 | |

Thermal Resistance

| Parameter | Symbol | Value | Unit |
|--|------------|----------------|------|
| Junction - soldering point ¹⁾ | R_{thJS} | | K/W |
| BAS70, BAS70-07 | | ≤ 310 | |
| BAS70-02L, BAS70-02W | | ≤ 130 ≤ 170 | |
| BAS70-04, BAS70-06 | | ≤ 410 | |
| BAS70-04S/W, BAS70-06W | | ≤ 210 | |
| BAS70-05 | | ≤ 510 | |
| BAS70-05W | | ≤ 240 | |
| BAS70-07W | | ≤ 145 | |
| BAS170W | | ≤ 190 | |

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|---|--------------|-------------------|-------------------|--------------------|---------------|
| | | min. | typ. | max. | |
| DC Characteristics | | | | | |
| Breakdown voltage $I_{(BR)} = 10 \mu\text{A}$ | $V_{(BR)}$ | 70 | - | - | V |
| Reverse current $V_R = 50 \text{ V}$ | I_R | - | - | 0.1 | μA |
| Forward voltage $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 15 \text{ mA}$ | V_F | 300 600 720 | 375 705 880 | 410 750 1000 | mV |
| Forward voltage matching ²⁾ $I_F = 10 \text{ mA}$ | ΔV_F | - | - | 20 | |

¹For calculation of R_{thJA} please refer to Application Note Thermal Resistance

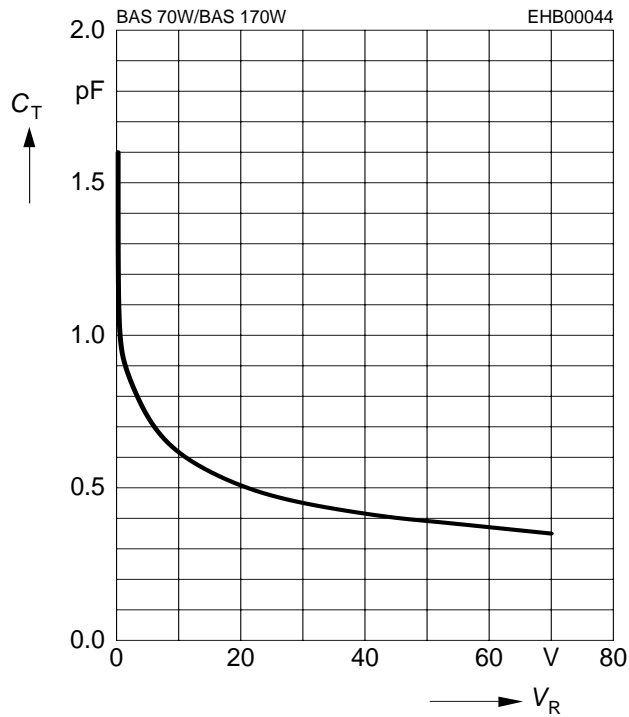
² ΔV_F is the difference between lowest and highest V_F in a multiple diode component.

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|---|-------------|--------|------|------|----------|
| | | min. | typ. | max. | |
| AC Characteristics | | | | | |
| Diode capacitance $V_R = 0$, $f = 1$ MHz | C_T | - | 1.5 | 2 | pF |
| Forward resistance $I_F = 10$ mA, $f = 10$ kHz | r_f | - | 34 | - | Ω |
| Charge carrier life time $I_F = 25$ mA | τ_{rr} | - | - | 100 | ps |

Diode capacitance $C_T = f(V_R)$

$f = 1\text{MHz}$



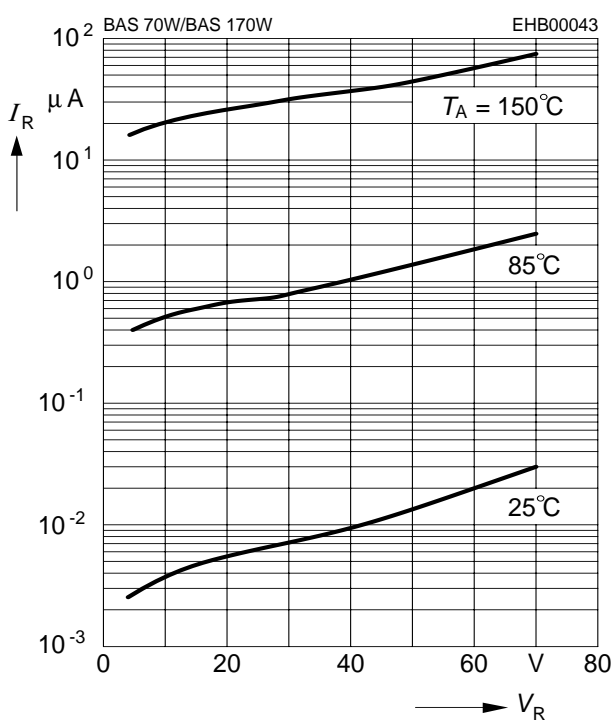
Forward resistance $r_f = f(I_F)$

$f = 10\text{kHz}$



Reverse current $I_R = f(V_R)$

$T_A = \text{Parameter}$



Forward current $I_F = f(V_F)$

$T_A = \text{Parameter}$



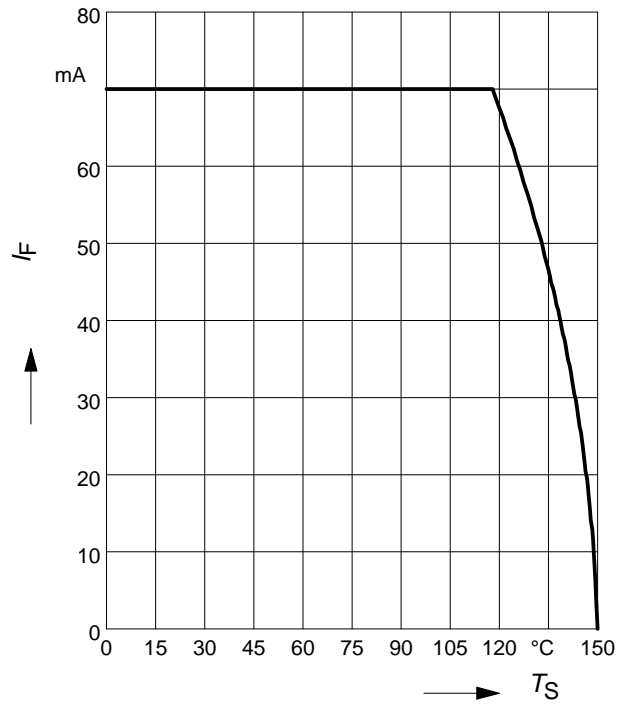
Forward current $I_F = f(T_S)$

BAS70, BAS70-07



Forward current $I_F = f(T_S)$

BAS70-02L



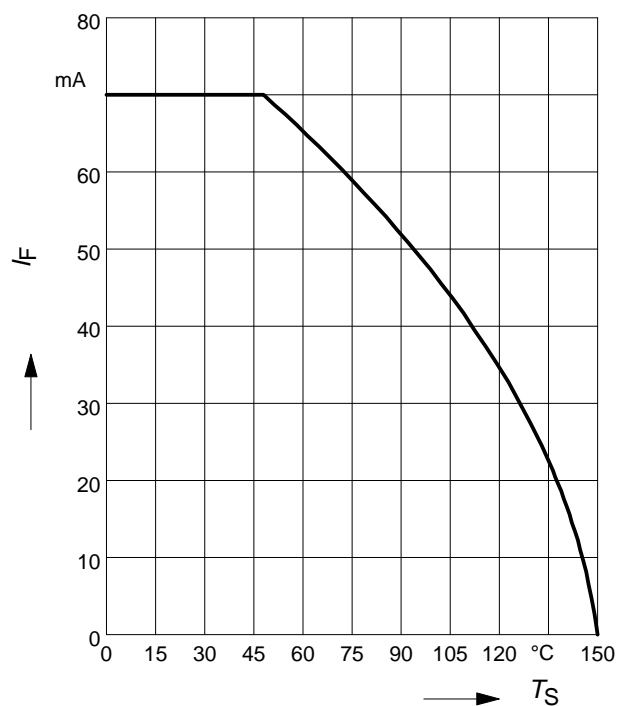
Forward current $I_F = f(T_S)$

BAS70-02W

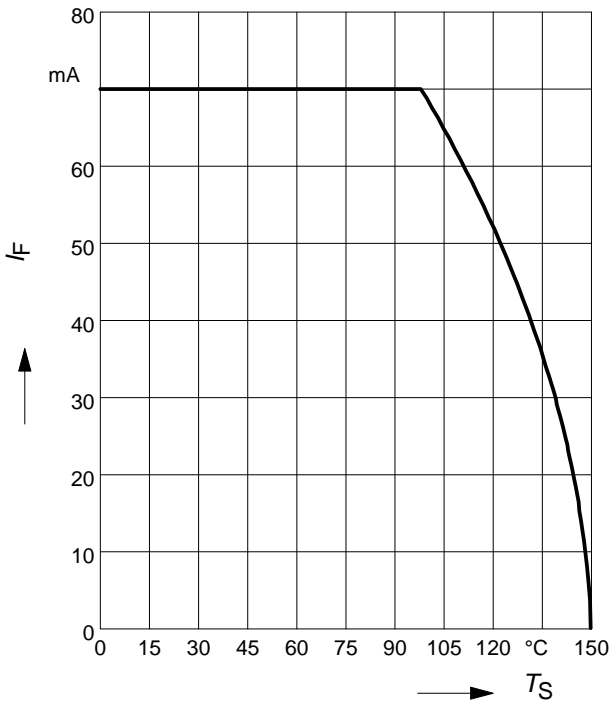


Forward current $I_F = f(T_S)$

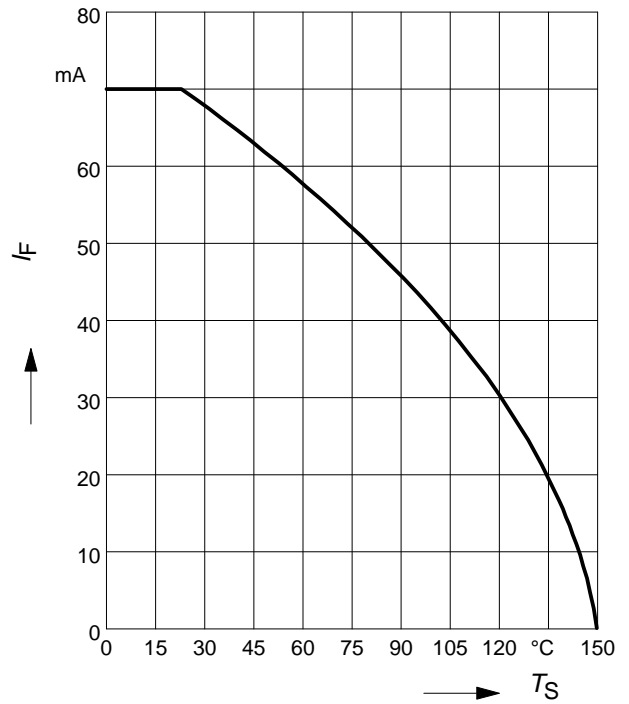
BAS70-04, BAS70-06



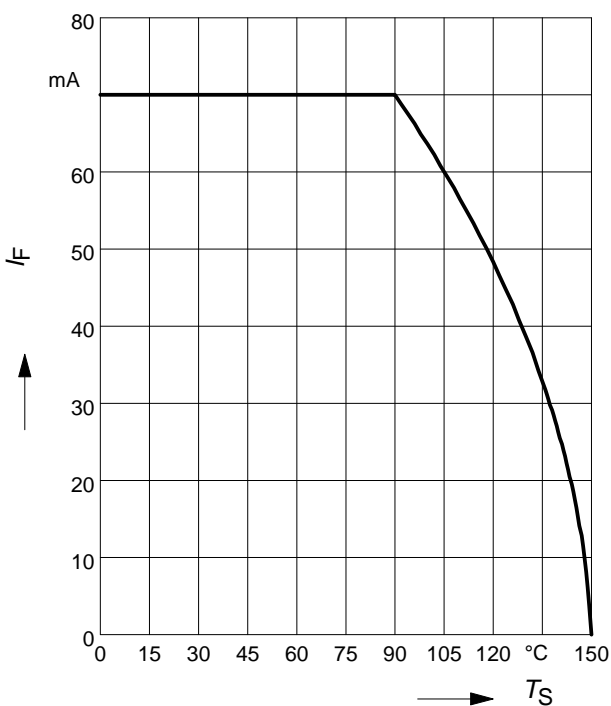
Forward current $I_F = f(T_S)$
 BAS70-04S/W, BAS70-06W, BAS170W



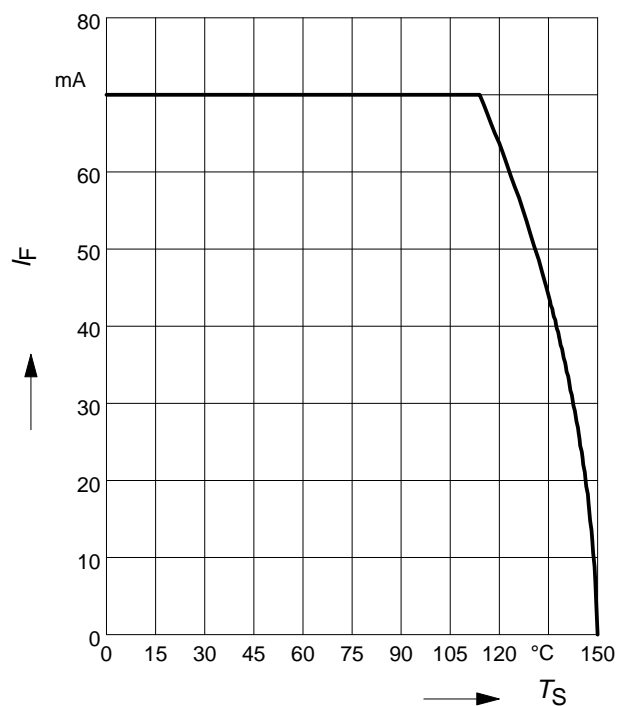
Forward current $I_F = f(T_S)$
 BAS70-05



Forward current $I_F = f(T_S)$
 BAS70-05W



Forward current $I_F = f(T_S)$
 BAS70-07W



Forward current $I_F = f(T_S)$

BAS170W



Permissible Puls Load $R_{thJS} = f(t_p)$

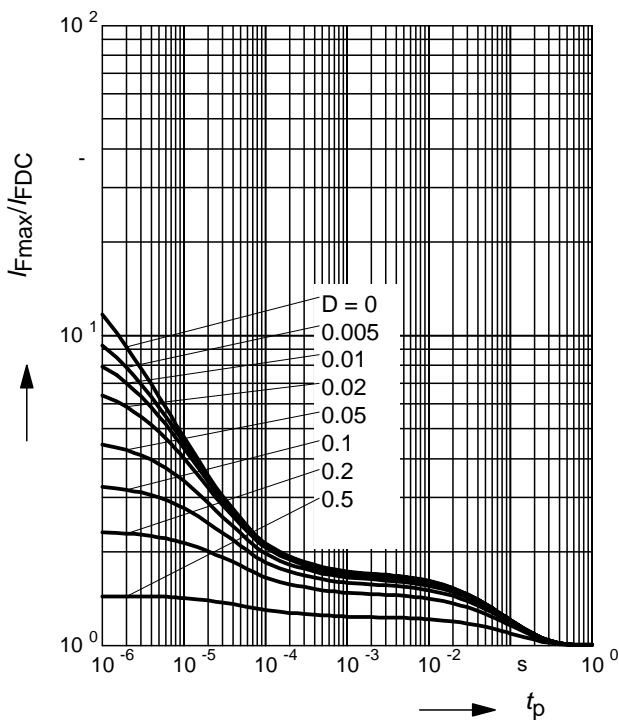
BAS70



Permissible Pulse Load

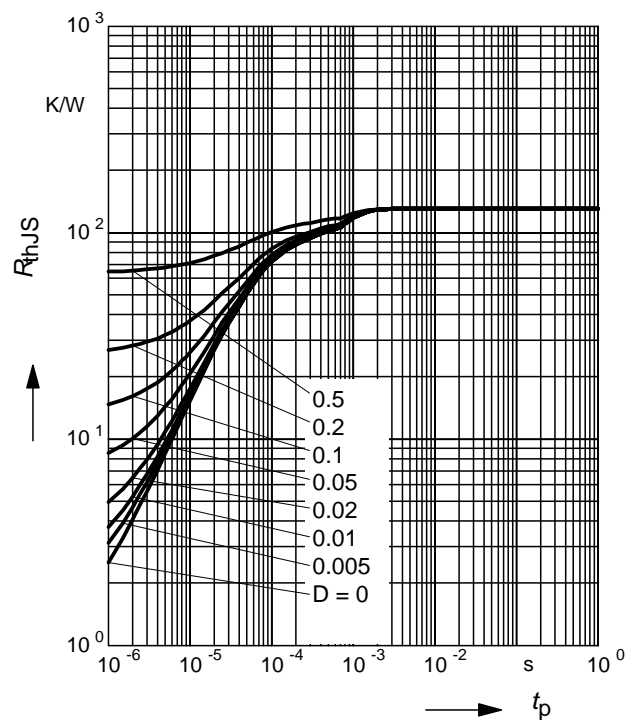
$I_{Fmax} / I_{FDC} = f(t_p)$

BAS70



Permissible Puls Load $R_{thJS} = f(t_p)$

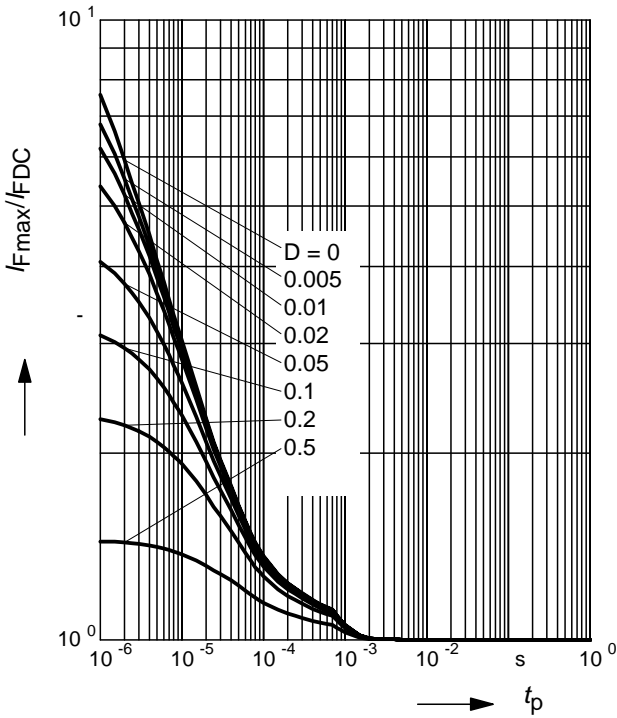
BAS70-02L



Permissible Pulse Load

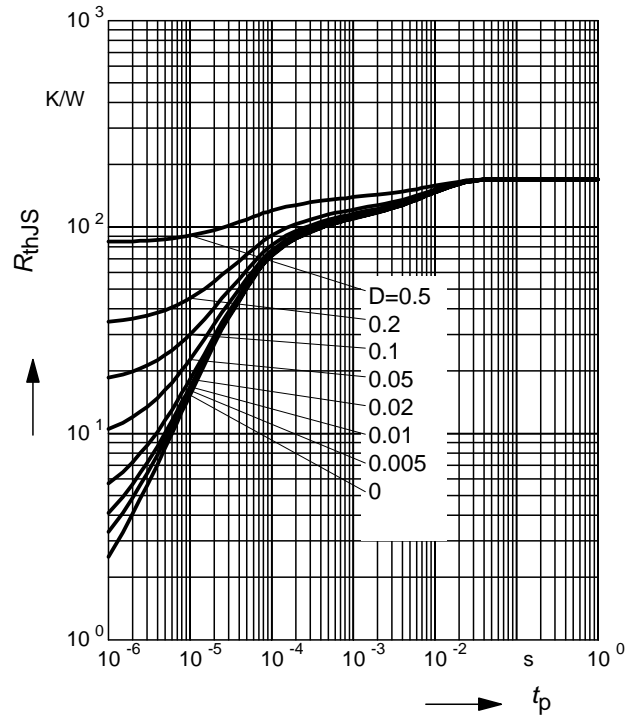
$I_{Fmax} / I_{FDC} = f(t_p)$

BAS70-02L



Permissible Puls Load $R_{thJS} = f(t_p)$

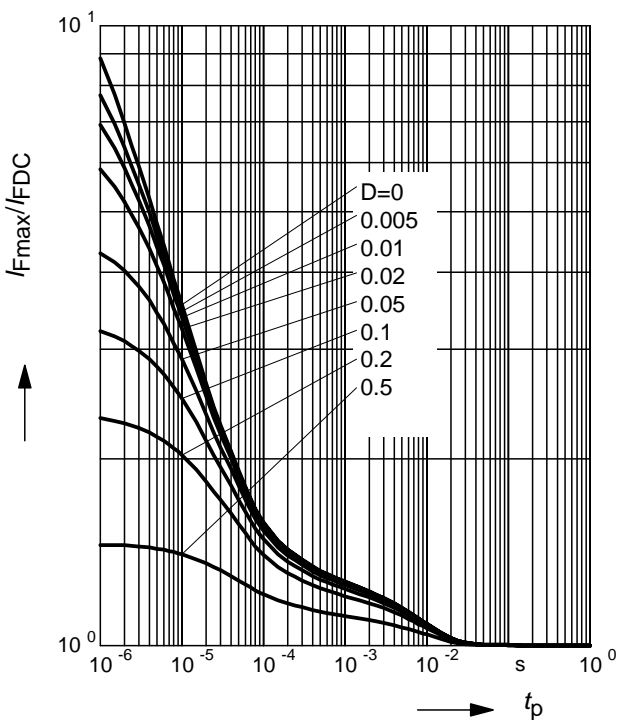
BAS70-02W



Permissible Pulse Load

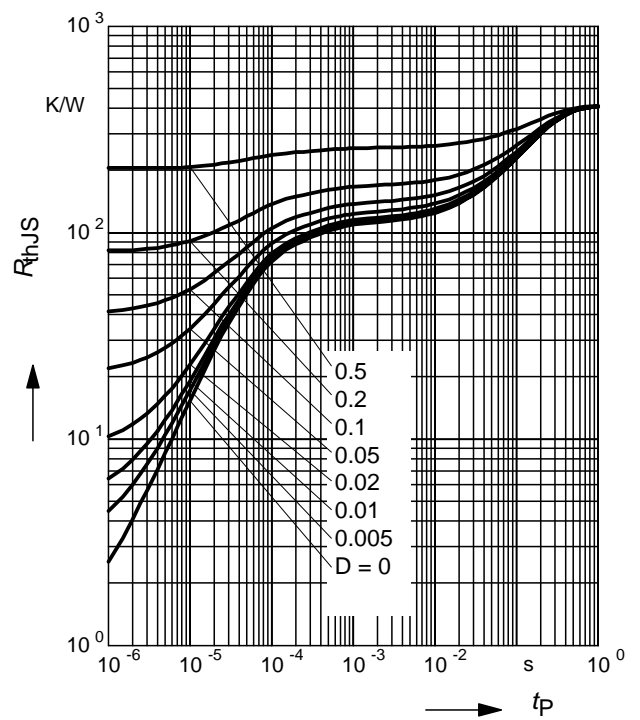
$I_{Fmax} / I_{FDC} = f(t_p)$

BAS70-02W



Permissible Puls Load $R_{thJS} = f(t_p)$

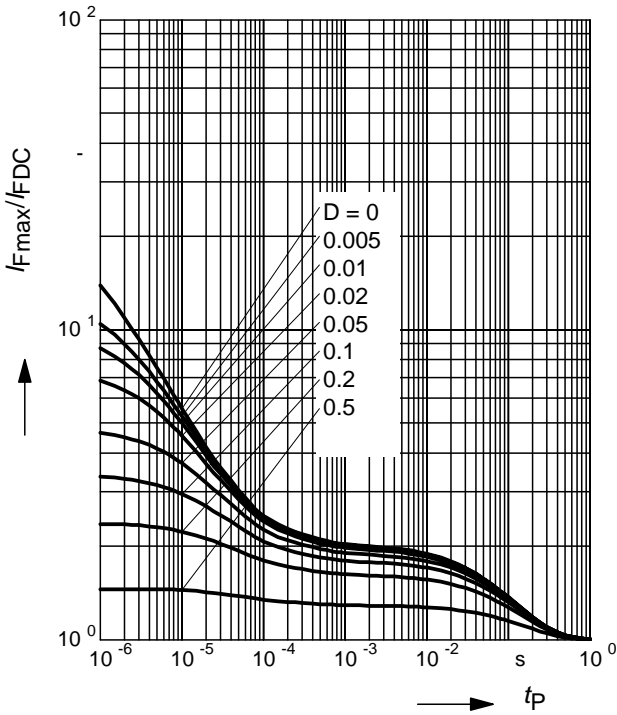
BAS70-04, BAS70-06



Permissible Pulse Load

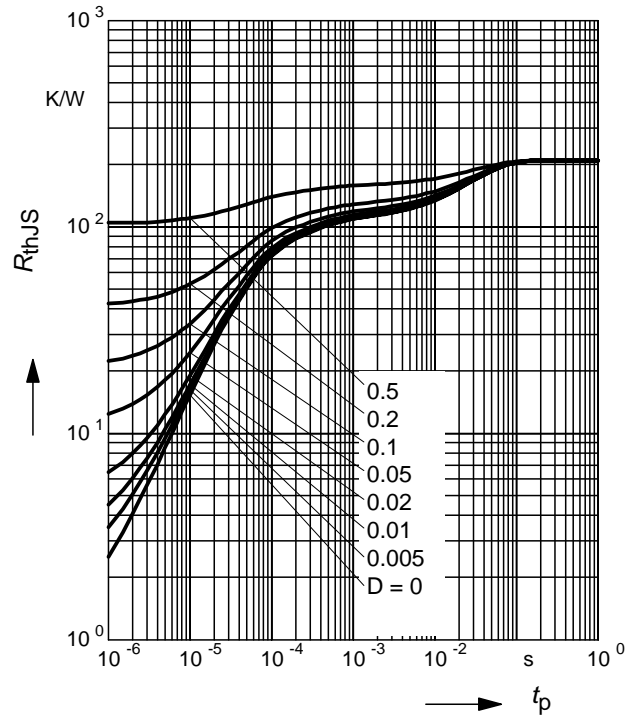
$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-04, BAS70-06



Permissible Puls Load $R_{thJS} = f(t_p)$

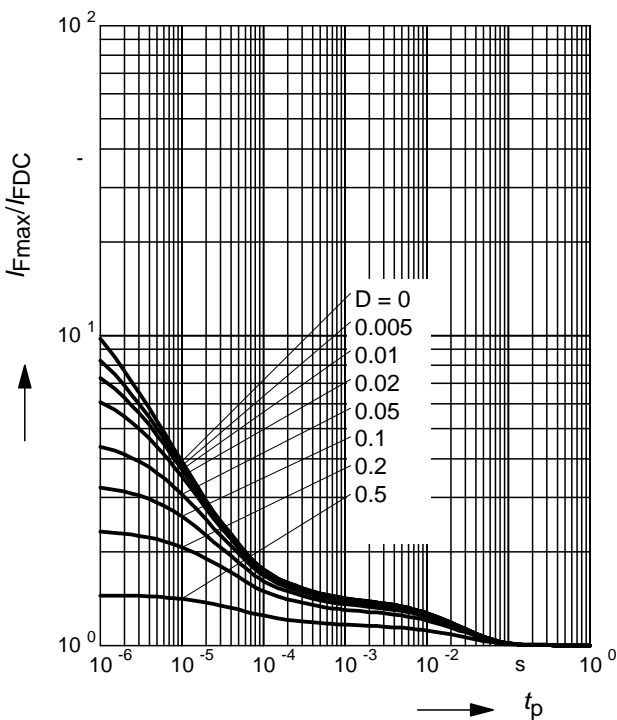
BAS70-04S



Permissible Pulse Load

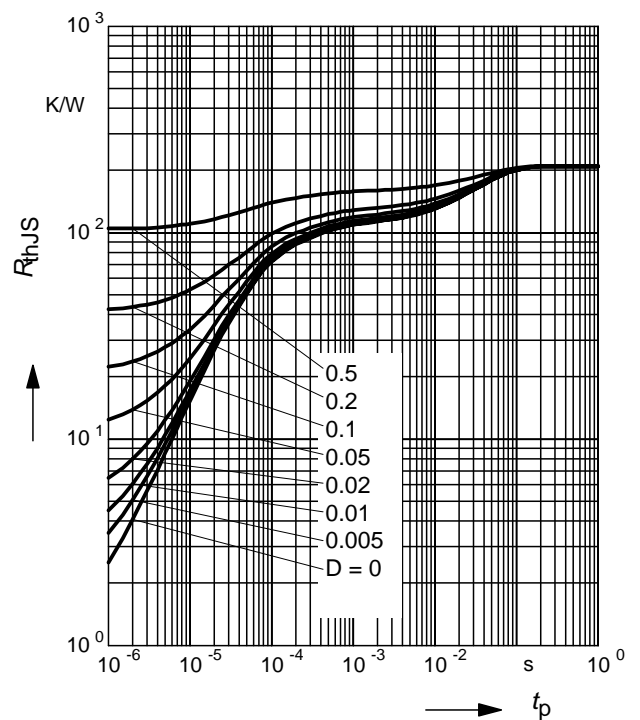
$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-04S



Permissible Puls Load $R_{thJS} = f(t_p)$

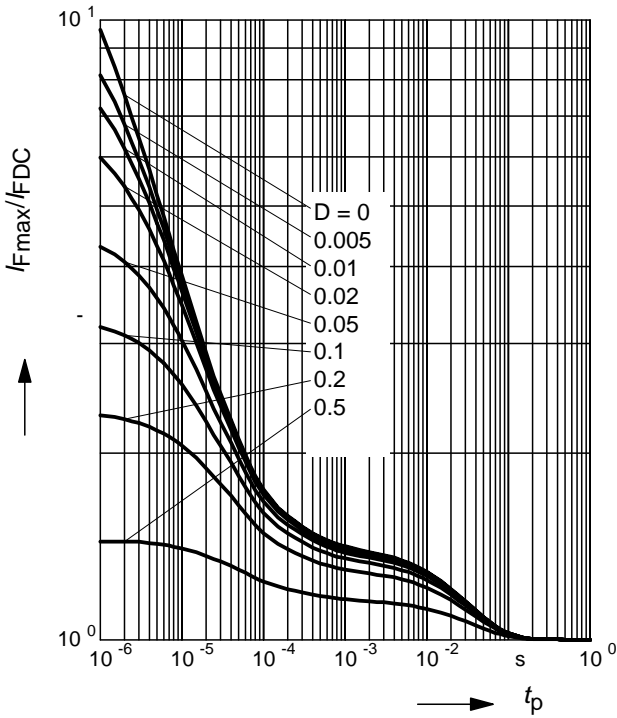
BAS70-04W, BAS70-06W



Permissible Pulse Load

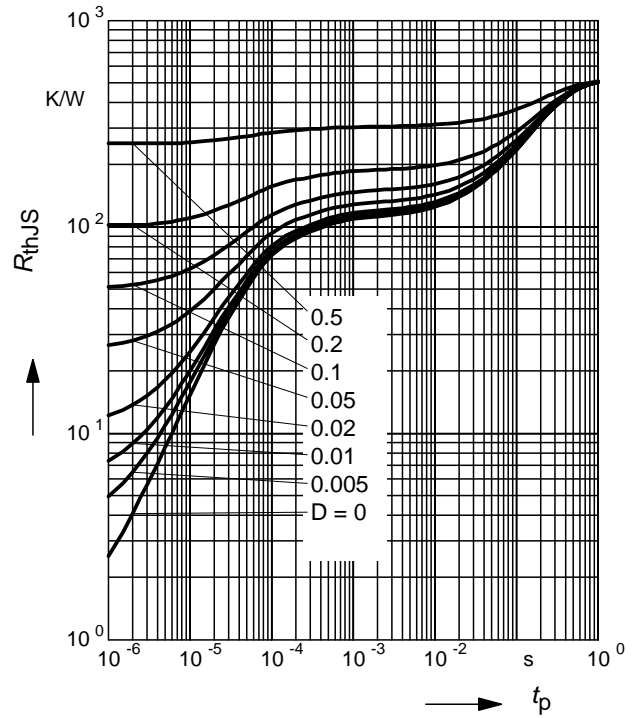
$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-04W, BAS70-06W



Permissible Puls Load $R_{thJS} = f(t_p)$

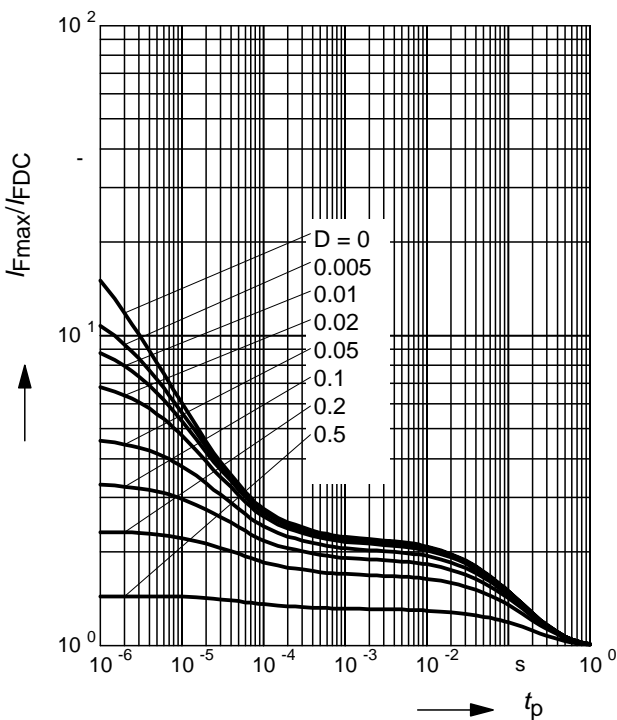
BAS70-05



Permissible Pulse Load

$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-05



Permissible Puls Load $R_{thJS} = f(t_p)$

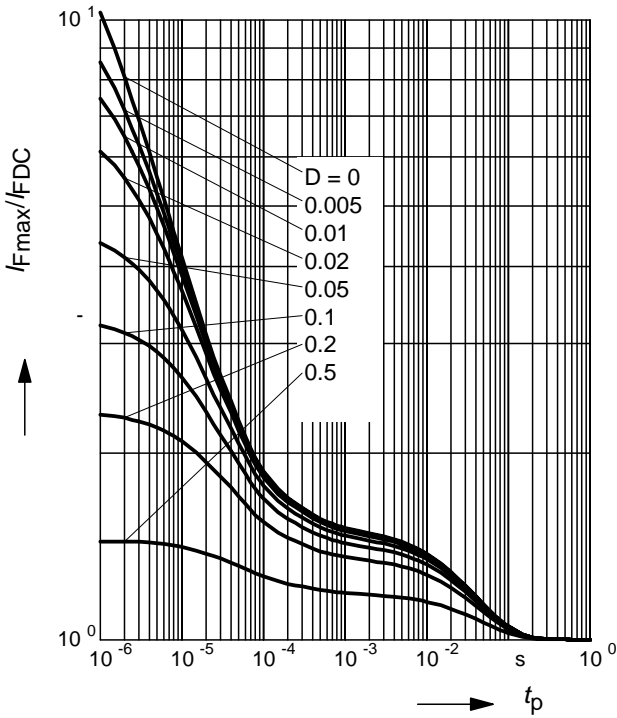
BAS70-05W



Permissible Pulse Load

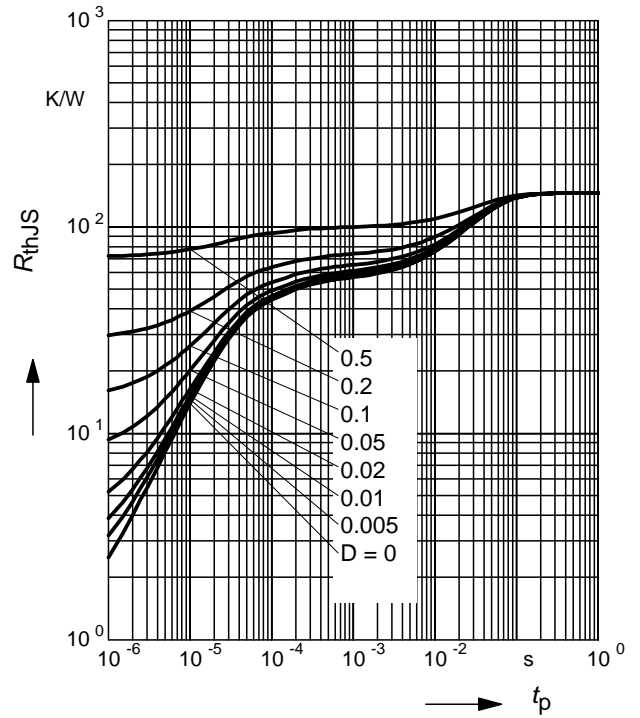
$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-05W



Permissible Puls Load $R_{thJS} = f(t_p)$

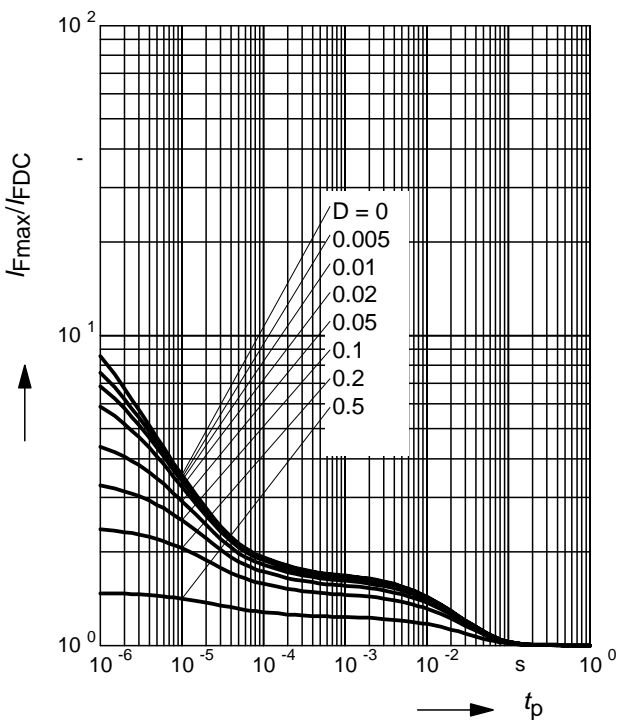
BAS70-07W



Permissible Pulse Load

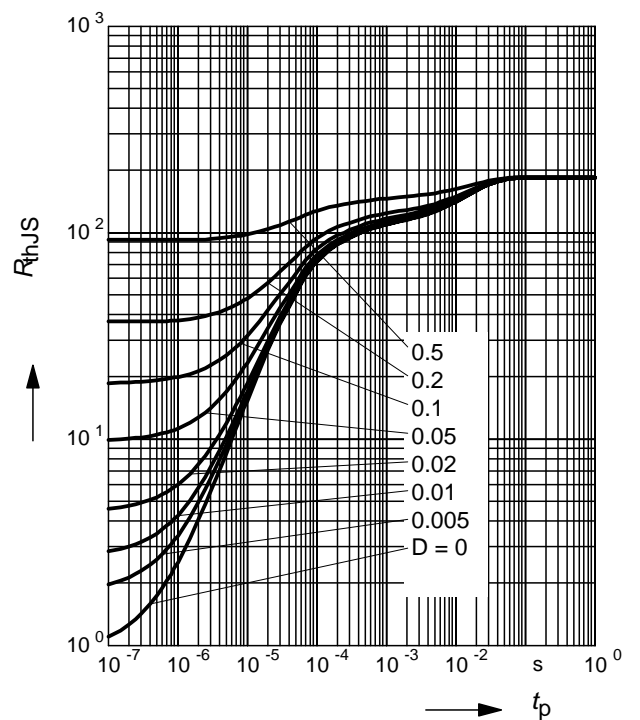
$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS70-07W



Permissible Puls Load $R_{thJS} = f(t_p)$

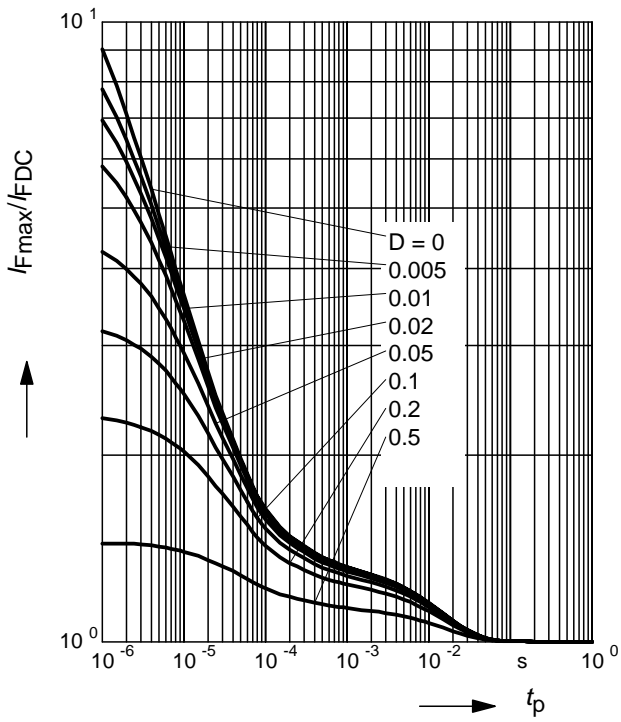
BAS170W



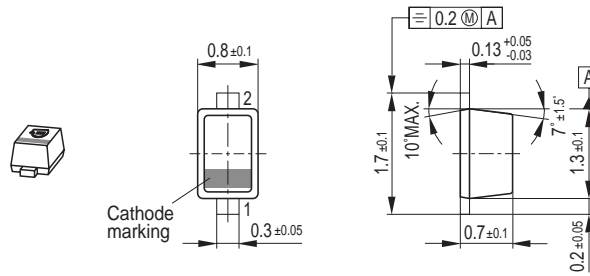
Permissible Pulse Load

$$I_{Fmax} / I_{FDC} = f(t_p)$$

BAS170W



Package Outline



Foot Print

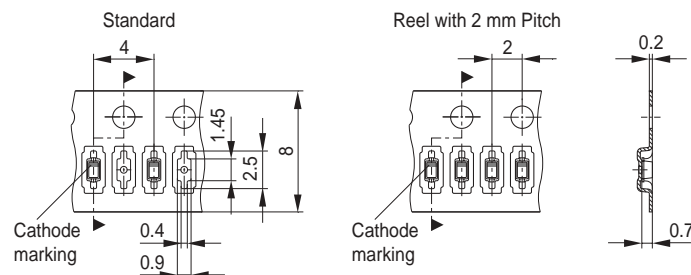


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel

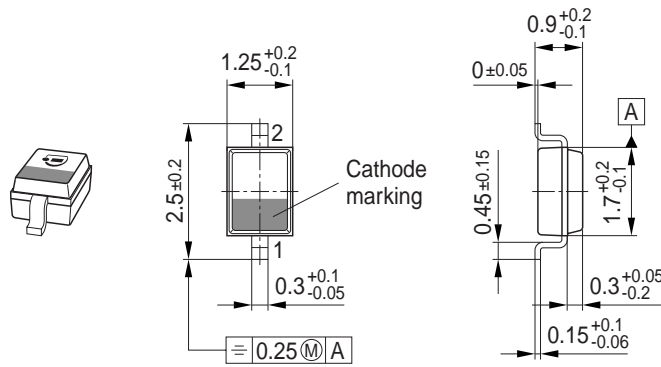


Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹⁾) CES-Code

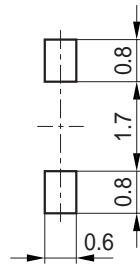
| Month | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| 01 | a | p | A | P | a | p | A | P | a | p | A | P |
| 02 | b | q | B | Q | b | q | B | Q | b | q | B | Q |
| 03 | c | r | C | R | c | r | C | R | c | r | C | R |
| 04 | d | s | D | S | d | s | D | S | d | s | D | S |
| 05 | e | t | E | T | e | t | E | T | e | t | E | T |
| 06 | f | u | F | U | f | u | F | U | f | u | F | U |
| 07 | g | v | G | V | g | v | G | V | g | v | G | V |
| 08 | h | x | H | X | h | x | H | X | h | x | H | X |
| 09 | j | y | J | Y | j | y | J | Y | j | y | J | Y |
| 10 | k | z | K | Z | k | z | K | Z | k | z | K | Z |
| 11 | l | 2 | L | 4 | l | 2 | L | 4 | l | 2 | L | 4 |
| 12 | n | 3 | N | 5 | n | 3 | N | 5 | n | 3 | N | 5 |

1) New Marking Layout for SC75, implemented at October 2005.

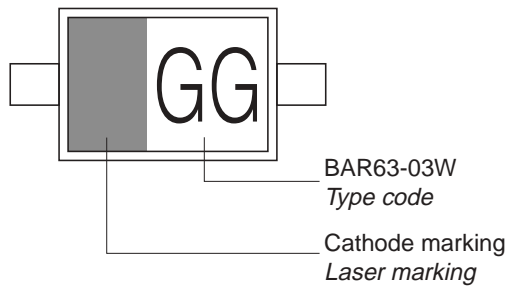
Package Outline



Foot Print

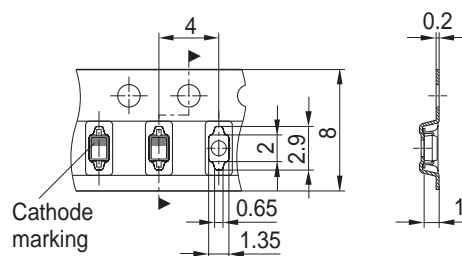


Marking Layout (Example)

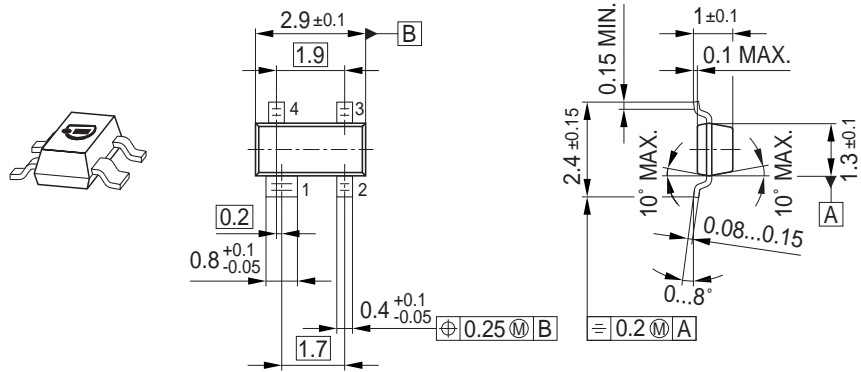


Standard Packing

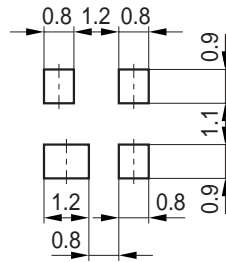
Reel \varnothing 180 mm = 3.000 Pieces/Reel
 Reel \varnothing 330 mm = 10.000 Pieces/Reel



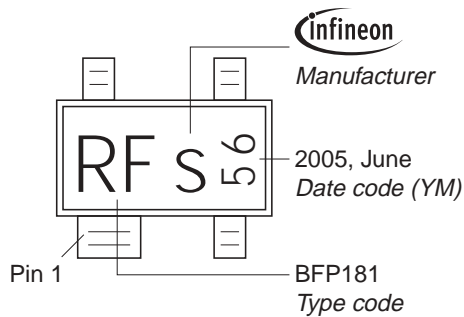
Package Outline



Foot Print

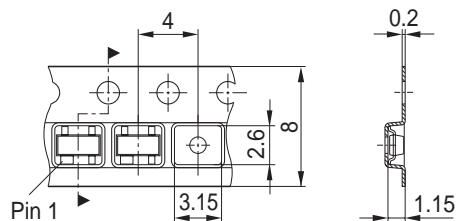


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel



Package Outline

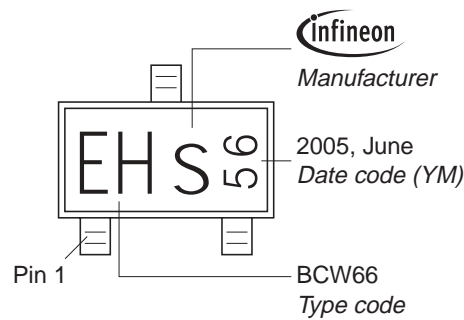


1) Lead width can be 0.6 max. in dambar area

Foot Print

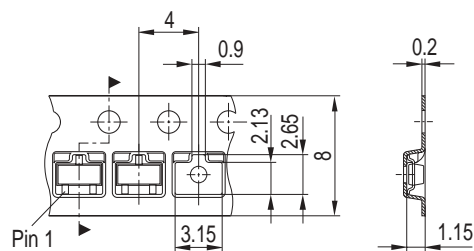


Marking Layout (Example)



Standard Packing

Reel \varnothing 180 mm = 3.000 Pieces/Reel
 Reel \varnothing 330 mm = 10.000 Pieces/Reel



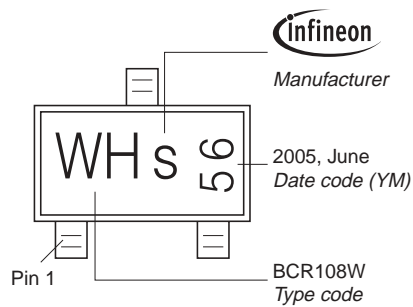
Package Outline



Foot Print

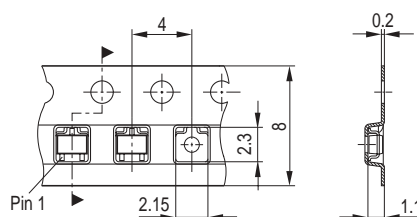


Marking Layout (Example)

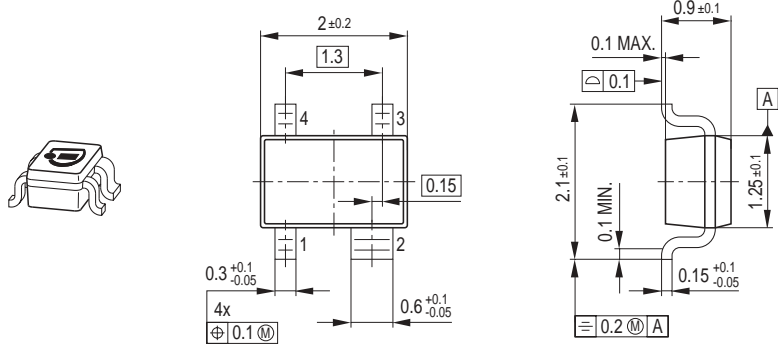


Standard Packing

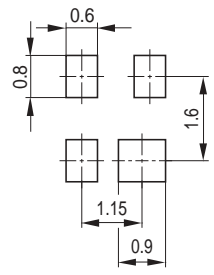
Reel \varnothing 180 mm = 3.000 Pieces/Reel
 Reel \varnothing 330 mm = 10.000 Pieces/Reel



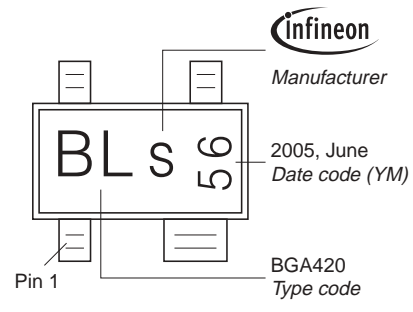
Package Outline



Foot Print

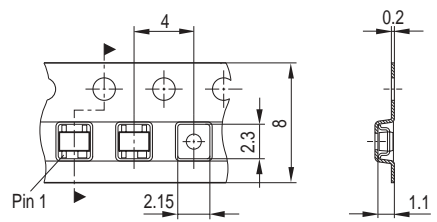


Marking Layout (Example)

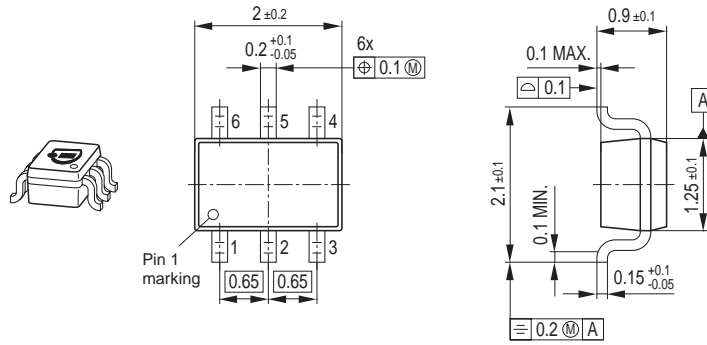


Standard Packing

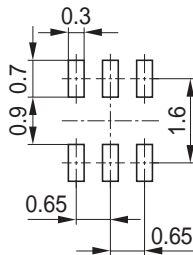
Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel



Package Outline

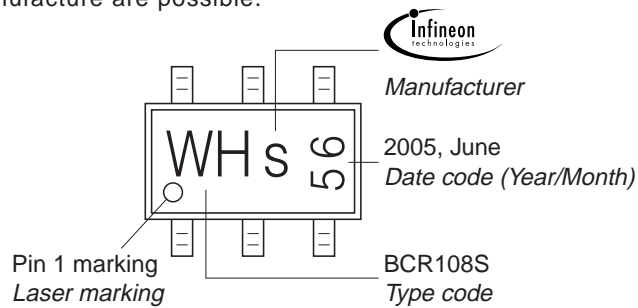


Foot Print



Marking Layout (Example)

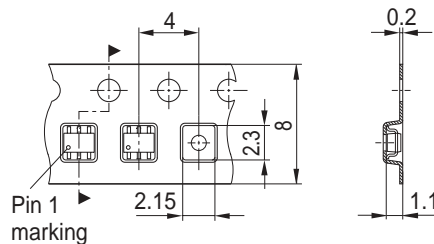
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel \varnothing 180 mm = 3.000 Pieces/Reel
 Reel \varnothing 330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



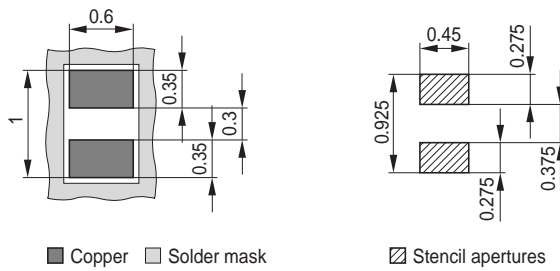
Package Outline



1) Dimension applies to plated terminal

Foot Print

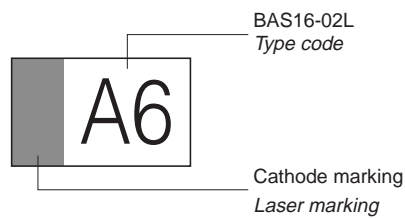
For board assembly information please refer to Infineon website "Packages"



■ Copper □ Solder mask

▨ Stencil apertures

Marking Layout (Example)

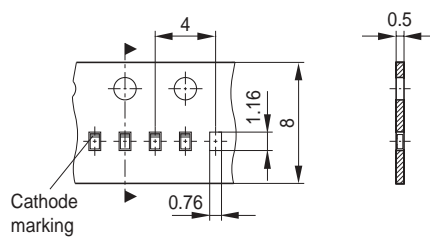


BAS16-02L
Type code

Cathode marking
Laser marking

Standard Packing

Reel \varnothing 180 mm = 15.000 Pieces/Reel
Reel \varnothing 330 mm = 50.000 Pieces/Reel (optional)



Edition 2006-02-01
Published by
Infineon Technologies AG
81726 München, Germany
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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